# DuPont<sup>™</sup> Kalrez<sup>®</sup> Perfluoroelastomer Parts

In Semiconductor Industry – Thermal Processes

DuPont<sup>™</sup> Kalrez<sup>®</sup> perfluoroelastomer parts have been used successfully in highly aggressive sealing environments for more than 40 years. Kalrez<sup>®</sup> parts have excellent chemical and thermal stability and have been specially formulated and processed to meet the unique requirements of wafer processing environments. DuPont Kalrez<sup>®</sup> seals are available in standard and custom sized O-rings, as well as customized shapes, that meet the demanding requirements of wafer processing in thermal environments. A proprietary ultraclean process and cleanroom handling is standard for all Kalrez<sup>®</sup> products utilized in the Semiconductor Industry.

## **Product Selector for Thermal Processes**

The following table provides a quick and easy tool for the selection of Kalrez® parts depending on the production process type:

Process Type	Maximum Service Temperature	Typical Chemistries	Suggested Products <sup>1</sup>
ALD / LPCVD / Metal CVD	250 °C to 300 °C	$WF_{6'}TiCl_{4'}SiH_{4},HF,F_{2'}Cl_{2'}O_{2'}H_2O$ Vapor, $ClF_3$	Kalrez <sup>®</sup> 8900/7075UP
Oxidation / Nitridation / Diffusion	280 °C to 300 °C	$N_2$ , $O_2$ , $H_2O$ Vapor, HCl, $Cl_2$ , $O_3$	Kalrez® 7075UP/8900
Lamp Anneal /RTP	250 °C to 275 °C	Infrared light, $O_{2'}$ H <sub>2</sub> O vapor	Kalrez® 8575
Wafer surface preparation	200 °C to 275 °C	NF <sub>3</sub> , NH <sub>3</sub> , HF, F <sub>2</sub> , H <sub>2</sub>	Kalrez <sup>®</sup> 9500/9600

1 Please consult the Kalrez® Application Guide and/or your Kalrez® Representative to assess performance fit for your specific application

#### **Typical Applications for Thermal Processes:**

- Quartz chamber seal
- Center ring

Fittings

Low dielectric curing processes

### Current Kalrez® Product Offerings for Thermal Application

#### Kalrez<sup>®</sup> 8900

Kalrez<sup>®</sup> 8900 parts are for **oxidation**, **diffusion**, **ALD**, and **LPCVD** applications. It offers outstanding thermal stability, **very low outgassing** and excellent (low) compression set properties. Kalrez<sup>®</sup> 8900 parts exhibit excellent retention of physical properties at elevated temperatures, have excellent mechanical strength and are well-suited for both static and dynamic sealing applications.

#### Kalrez<sup>®</sup> 8575

Kalrez<sup>®</sup> 8575 parts are developed for **oxidation**, **diffusion**, **lamp anneal** and RTP sealing applications. Kalrez<sup>®</sup> 8575 exhibits excellent thermal stability and long-term sealing performance, **less Infrared (IR) absorption and significantly reduced outgassing properties at elevated temperatures.** It also has good mechanical properties and is well-suited for both static and low stress/low sealing force applications.

#### Kalrez<sup>®</sup> 7075UP

Kalrez<sup>®</sup> 7075UP parts are targeted specifically **metal CVD applications**. They offer outstanding thermal stability, **very low outgassing** and excellent compression set properties. Kalrez<sup>®</sup> 7075UP exhibits **excellent seal force retention**, has good mechanical properties and is well suited for both static and dynamic sealing applications.

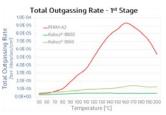
Ultrapure post-cleaning and packaging is standard for all parts made from Kalrez<sup>®</sup> 7075UP.

#### Kalrez<sup>®</sup> 9500

Kalrez<sup>®</sup> 9500 parts are targeted specifically for **deposition processes where ozone, ammonia and water vapor are used for processing, e.g. SACVD, FCVD, PECVD curing** processes, etc. It has been specifically designed for use in applications where the plasma environment is more "chemical", i.e., where oxygen and fluorine radicals are more dominant. Kalrez<sup>®</sup> 9500 also offers outstanding thermal stability, **very low outgassing** and excellent mechanical strength and is well suited for both static and dynamic sealing applications.

#### Kalrez<sup>®</sup> 9600

Kalrez<sup>®</sup> 9600 parts are designed for high purity, high temperature vacuum applications where seals are exposed to damaging Fluorine and Oxygen plasma radicals. It has an **extremely low erosion rate and weight loss from plasma attack** and provides **excellent chemical resistance to Ammonia, Ozone, and Water Vapor**. Its outstanding resilience in compression and **ultra-low outgassing at high temperature conditions** makes it especially suitable for applications where purity is paramount, such as Plasma-Enhanced Atomic Layer Deposition and Chemical Vapor Deposition processes.



Kalrez® 8900 parts: very low outgassing vs cometitive FFKM products



Kalrez® 8575 part



Kalrez® 7075UP O-Rings

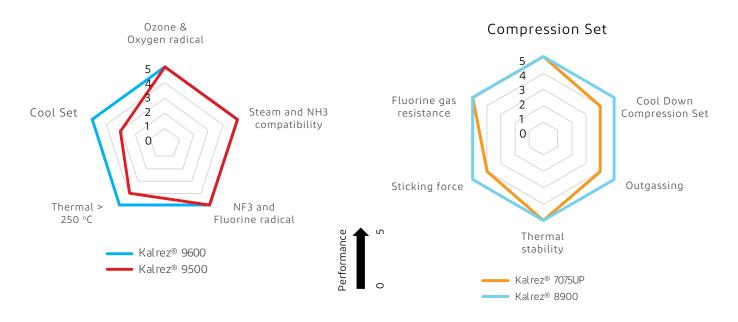


Kalrez<sup>®</sup> 9500 parts are based on a proprietary crosslinking system which is only available from DuPont



Kalrez® 9600 O-Rings

## **Typical Product Positioning**



## **Typical Physical Properties\***

Kalrez <sup>®</sup> grade	Color	Hardness <sup>1</sup> , Shore A	Maximum Service Temperature <sup>2</sup> , °C (°F)	Compression Set <sup>3</sup> at 70 hours, 204 °C, %
8900	Black	76 <sup>4</sup>	325 (617)	20
8575	White	63	300 (572)	25
7075UP	Black	75	327 (621)	13
9500	Tan	76 <sup>4</sup>	310 (590)	18
9600	Olive-Green	704	315 (599)	12

ASTM D2240 (pellet test specimens unless otherwise noted)
DuPont proprietary test method; useful temperature range may vary with seal design and application specifics
ASTM D395B and ASTM D1414 (AS568 K214 O-ring test specimens unless otherwise noted)
ASTM D2240 (plied slab test specimens)

\* Not to be used for specification purposes

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